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Infineon Ref No. IO040203PUS
MMB Ref No. 1890-0061

DECLARATION FOR PATENT APPLICATION, POWER OF ATTORNEY & DESIGNATION OF CORRESPONDENCE ADDRESS

As below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

Semiconductor Structure with Increased Breakdown Voltage and Method for Producing the Semiconductor Structure

the specification of which (check one)

_____ is attached hereto.

X was filed on 17 February 2004 as Application Serial No. 10/780,276

I hereby state that I have reviewed and understand the contents of the above-identified specification including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information known to me to be material to the patentability of this application in accordance with 37 CFR §1.56(a).

PRIOR FOREIGN/PCT APPLICATION(S) FILED WITHIN 12 MONTHS (6 MONTHS FOR DESIGN) PRIOR TO THIS APPLICATION AND ANY PRIORITY CLAIMS UNDER 35 U.S.C. § 119(a)-(d)

I hereby claim foreign priority benefits under 35 USC § 119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior Foreign Application(s)			Priority Claimed	
Number	Country	Day/Month/Year Filed	Yes	No
103 06 597.0-33	Germany	17 February 2003	X	

CLAIM FOR BENEFIT OF PRIOR U.S. PROVISIONAL APPLICATION(S) (35 U.S.C. § 119(e))

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Infineon Ref No. IO040203PUS
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I hereby claim the benefit under Title 35, United States Code, § 119 (e) of any United States provisional application(s) listed below:

Provisional Application Number	Filing Date

**CLAIM FOR BENEFIT OF EARLIER US/PCT APPLICATION(S)
UNDER 35 U.S.C. § 120**

I hereby claim the benefits under 35 USC § 120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of 35 USC § 112, I acknowledge the duty to disclose material information as defined in 37 CFR § 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Appl. No.	Filing Date	Patented, Pending, Abandoned

Power of Attorney: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith.

Erik O. Berger, Reg. No. 42,315; Stanton C. Braden, Reg. No. 32,556; Marie-Claire B. Maple, Reg. No. 37,588; Harold C. Moore, Reg. No. 37,892, Paul J. Maginot, Reg. No. 34,984, Michael D. Beck, Reg. No. 32,722, David M. Lockman, Reg. No. 34,214, David B. Quick, Reg. No. 31,933, James D. Wood, Reg. No. 43,285, and Russell E. Fowler, Reg. No. 43,615.

Send correspondence to:

Harold C. Moore
Maginot, Moore & Beck
Bank One Center/Tower
111 Monument Circle, Suite 3000
Indianapolis, Indiana 46204

Direct telephone calls to:

Harold C. Moore
telephone: (317) 638-2922
Facsimile: (317) 638-2139

I hereby declare that all statements made herein on my own knowledge are true and that all statements made on information and belief are believed to be true, and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both under

18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of First Inventor: Armin Tilke	
Inventor's Signature: <i>Armin Tilke</i>	Date: 06/15/04
Residence: Helgolandstr. 4, 01097 Dresden, Germany	
Citizenship: Germany	
Mailing Address: Helgolandstr. 4, 01097 Dresden, Germany	

Full Name of Second Inventor: Wolfgang Klein	
Inventor's Signature:	Date:
Residence: Am Wall 15, 85604 Zorneding, Germany	
Citizenship: Germany	
Mailing Address: Am Wall 15, 85604 Zorneding, Germany	



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18 USC §1001 and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Full Name of First Inventor: Armin Tilke	
Inventor's Signature:	Date:
Residence: Helgolandstr. 4, 01097 Dresden, Germany	
Citizenship: Germany	
Mailing Address: Helgolandstr. 4, 01097 Dresden, Germany	

Full Name of Second Inventor: Wolfgang Klein	
Inventor's Signature: <i>Wolfgang Klein</i>	Date: <i>16 June 2004</i>
Residence: Am Wall 15, 85604 Zorneding, Germany	
Citizenship: Germany	
Mailing Address: Am Wall 15, 85604 Zorneding, Germany	